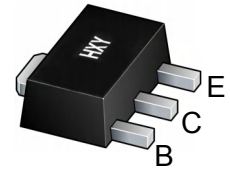




## FEATURES

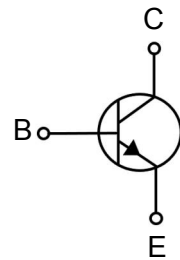
- Collector Current:  $I_C=3A$
- Power Dissipation of 500mw



SOT89-3L

## Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
D882	SOT89-3L	D882	1000



## MAXIMUM RATINGS (Ta=25 unless otherwise noted)

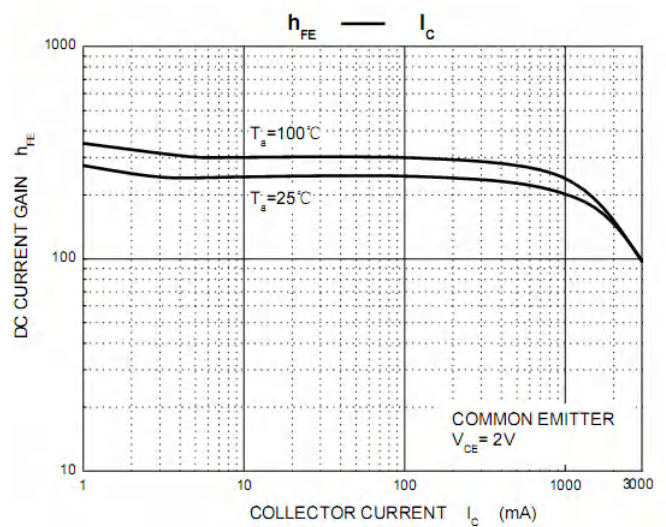
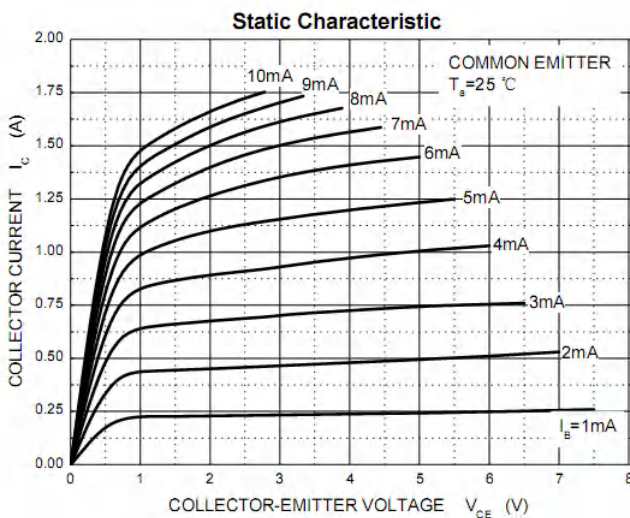
Parameter	Symbol	Limit	Unit
Collector-Base Voltage	$V_{CBO}$	40	V
Collector-Emitter Voltage	$V_{CEO}$	30	V
Emitter-Base Voltage	$V_{EBO}$	5	V
Collector Current	$I_C$	3	A
Collector Power Dissipation	$P_C$	500	mW
Thermal Resistance From Junction To Ambient	$R_{OJA}$	250	$^{\circ}C/W$
Junction Temperature	$T_J$	150	$^{\circ}C$
Storage Temperature	$T_{stg}$	-55~+150	$^{\circ}C$

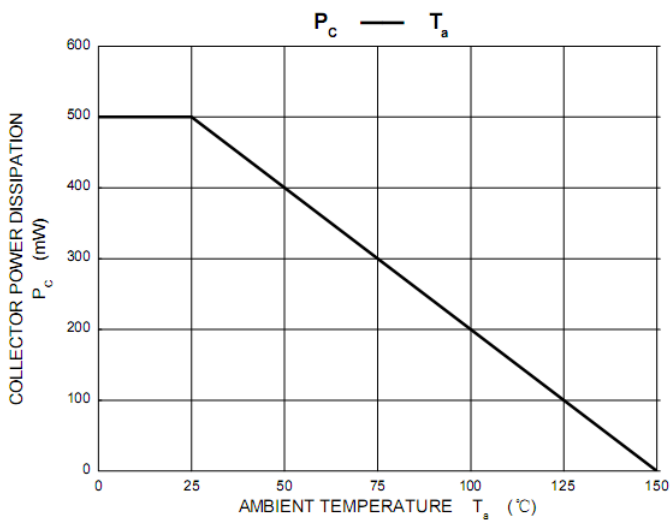
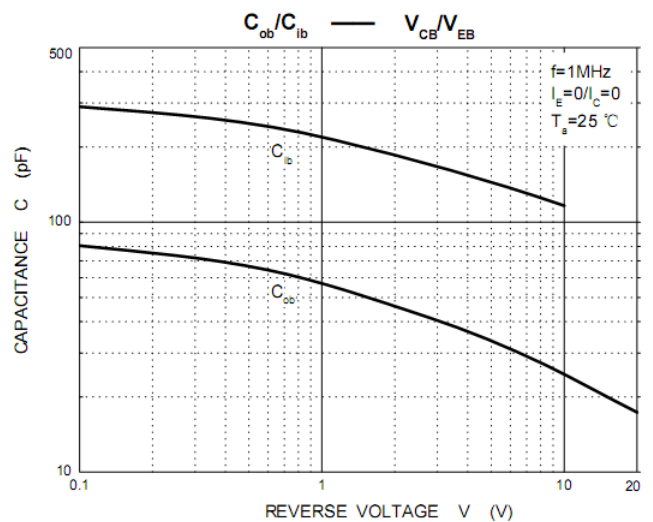
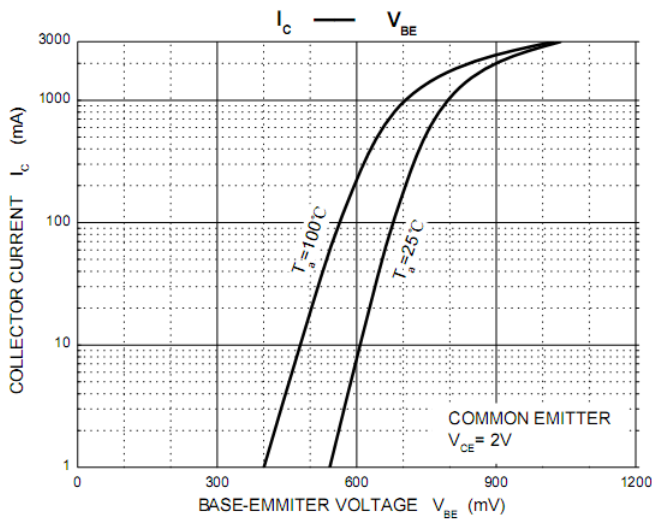
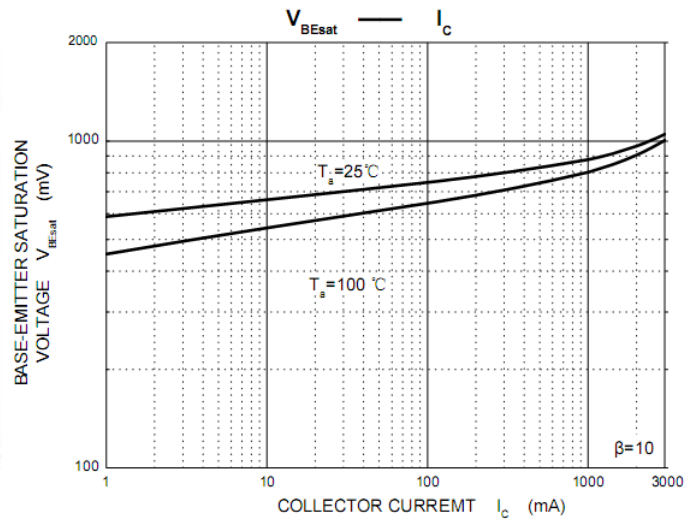
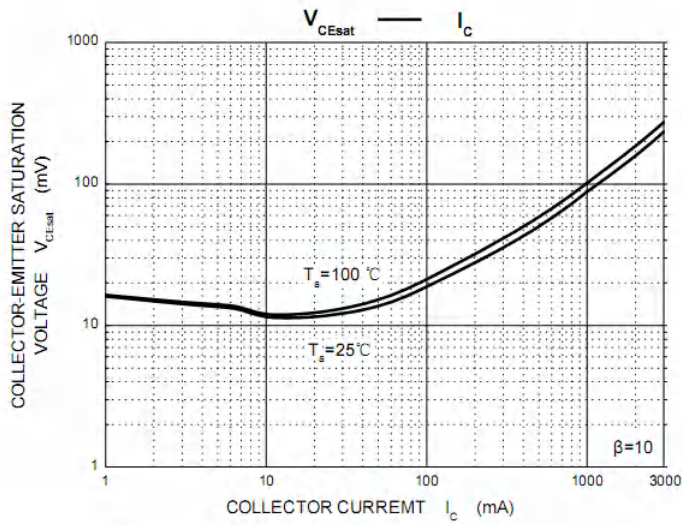


**ELECTRICAL CHARACTERISTICS (T<sub>a</sub>=25 unless otherwise specified)**

Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
Collector-base breakdown voltage	V <sub>(BR)CBO</sub>	I <sub>C</sub> = 100μA, I <sub>E</sub> =0	40			V
Collector-emitter breakdown voltage	V <sub>(BR)CEO</sub>	I <sub>C</sub> = 10mA, I <sub>B</sub> =0	30			V
Emitter-base breakdown voltage	V <sub>(BR)EBO</sub>	I <sub>E</sub> = 100μA, I <sub>C</sub> =0	6			V
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = 40V, I <sub>E</sub> =0			1	μA
Collector cut-off current	I <sub>CEO</sub>	V <sub>CE</sub> = 30V, I <sub>B</sub> =0			10	μA
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> = 6V, I <sub>C</sub> =0			1	μA
DC current gain	h <sub>FE(1)</sub>	V <sub>CE</sub> =2V, I <sub>C</sub> = 1A	160		320	
	h <sub>FE(2)</sub>	V <sub>CE</sub> =2V, I <sub>C</sub> = 100mA	32			
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> = 2A, I <sub>B</sub> = 0.2 A			0.5	V
Base-emitter saturation voltage	V <sub>BE(sat)</sub>	I <sub>C</sub> = 2A, I <sub>B</sub> = 0.2 A			1.5	V
Transition frequency	f <sub>T</sub>	V <sub>CE</sub> = 5V, I <sub>C</sub> =0.1A f =10MHz	50			MHz

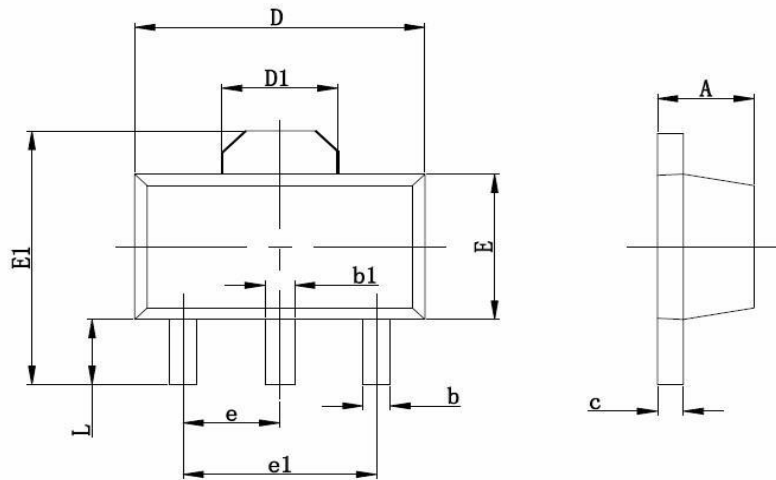
**Typical Characteristics**







### SOT89-3L Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.400	1.600	0.055	0.063
b	0.350	0.520	0.013	0.197
b1	0.400	0.580	0.016	0.023
c	0.350	0.440	0.014	0.017
D	4.400	4.600	0.173	0.181
D1	1.550 REF		0.061 REF	
E	2.350	2.550	0.091	0.102
E1	3.940	4.250	0.155	0.167
e	1.500 TYP		0.060TYP	
e1	3.000 TYP		0.118TYP	
L	0.900	1.100	0.035	0.047



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